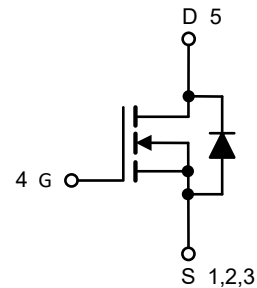
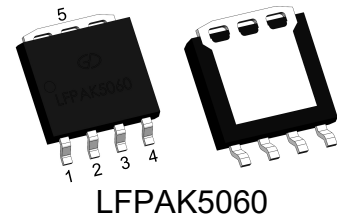


N-Channel 40V (D-S) Power MOSFET

Features

- 100% Avalanche Tested
- Extremely Low Losses with Low FOM $R_{ds(on)} \cdot Q_g$
- RoHS Compliant, Halogen Free, Pb-Free
- AEC-Q101 Qualified
- MSL 1



Applications

- Automotive systems
- Motors, lamps and solenoid control
- Ultra high performance power switching

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|--|-----------------|-------------------------|------------------|
| Drain-Source Voltage | V_{DS} | 40 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Drain Current, Continuous $V_{GS}=10\text{V}$ | I_D | $T_C=25^\circ\text{C}$ | 365 |
| | | $T_C=100^\circ\text{C}$ | 231 |
| Drain Current, Pulsed (Note 1) | I_{DM} | 1095 | A |
| Single Avalanche Energy (Note 2) | E_{AS} | 703 | mJ |
| Power Dissipation | P_D | $T_C=25^\circ\text{C}$ | 234 |
| | | $T_C=100^\circ\text{C}$ | 117 |
| Operating Junction/ Storage Temperature Range | T_J / T_{STG} | -55 to +175 | $^\circ\text{C}$ |

Note 1: Single pulse; $t_p \leq 1\mu\text{s}$.

Note 2: $V_{DD} = 20\text{V}$, $V_{GS} = 10\text{V}$, $L = 0.5\text{mH}$, $R_G = 25\Omega$, starting $T_J = 25^\circ\text{C}$.

Thermal Characteristics

| Parameter | Symbol | Max. | Unit |
|---|------------|------|--------------------|
| Thermal Resistance Junction to Case | R_{thJC} | 0.64 | $^\circ\text{C/W}$ |
| Thermal Resistance Junction to Ambient (Note 3) | R_{thJA} | 62.5 | $^\circ\text{C/W}$ |

Note 3: Device mounted on 1 square inch FR4 PCB board, with 2oz single-sided copper, in a 25°C still air environment.

| Electrical Characteristics (T _J =25°C unless otherwise noted) | | | | | | |
|--|----------------------|--|------|------|------|------|
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | V _{GS} =0V, I _D =250μA, | 40 | -- | -- | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =40V, V _{GS} =0V | -- | -- | 1 | uA |
| Gate Threshold Voltage | V _{GS(TH)} | V _{DS} =V _{GS} , I _D =250uA | 2 | -- | 4 | V |
| Gate Leakage Current | I _{GSS} | V _{GS} =±20V, V _{DS} =0V | -- | -- | ±100 | nA |
| Drain-Source On-state Resistance (Note 4) | R _{DS(on)} | V _{GS} =10V, I _D =20A | -- | 0.9 | 1.1 | mΩ |
| Total Gate Charge | Q _g | V _{GS(off)} =0V, V _{GS(on)} =10V, V _{DS} =30V, I _D =40A | -- | 62 | -- | nC |
| Gate-Source Charge | Q _{gs} | | -- | 18 | -- | |
| Gate-Drain Charge | Q _{gd} | | -- | 19 | -- | |
| Turn-on Delay Time | t _{d(on)} | V _{GS} =10V, V _{DS} =20V, R _L =0.75Ω, R _G =3Ω | -- | 14 | -- | ns |
| Turn-on Rise Time | t _r | | -- | 23 | -- | |
| Turn-off Delay Time | t _{d(off)} | | -- | 31 | -- | |
| Turn-off Fall Time | t _f | | -- | 23 | -- | |
| Gate Resistance | R _g | V _{GS} =0V, f=1MHz, open drain | -- | 2.2 | -- | Ω |
| Input Capacitance | C _{iss} | V _{GS} =0V, V _{DS} =40V, f=1MHz | -- | 4149 | -- | pF |
| Output Capacitance | C _{oss} | | -- | 1463 | -- | |
| Reverse Transfer Capacitance | C _{rss} | | -- | 76 | -- | |

| Reverse Diode Characteristics (T _J =25°C unless otherwise noted) | | | | | | |
|---|-----------------|--|------|------|------|------|
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| Forward Current, Continuous | I _{SD} | T _C =25°C | -- | -- | 302 | A |
| Diode Forward Voltage (Note 4) | V _{SD} | I _F =20A, V _{GS} =0V | -- | -- | 1.2 | V |
| Reverse Recovery Time | T _{rr} | V _R =20V, I _F =6A, di/dt = 100 A/μs | -- | 62 | -- | ns |
| Reverse Recovery Charge | Q _{rr} | | -- | 65 | -- | nC |

Note 4: Pulse test; pulse width ≤ 380μs, duty cycle ≤ 1%.

Typical Characteristics Curves (T_J = 25°C unless otherwise noted)

Fig. 1 - Output Characteristics

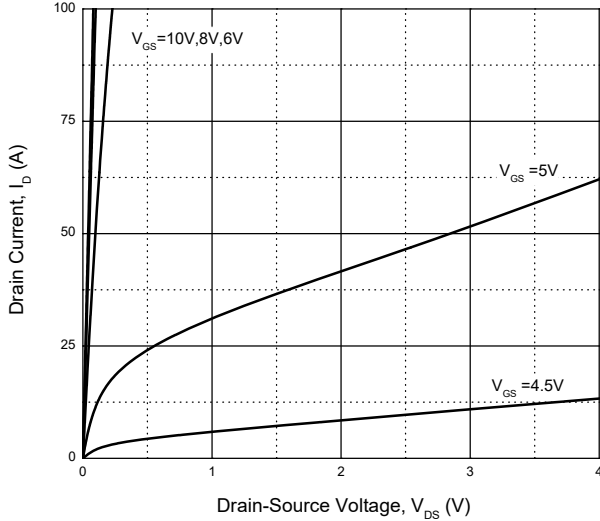


Fig. 2 - Transfer Characteristics

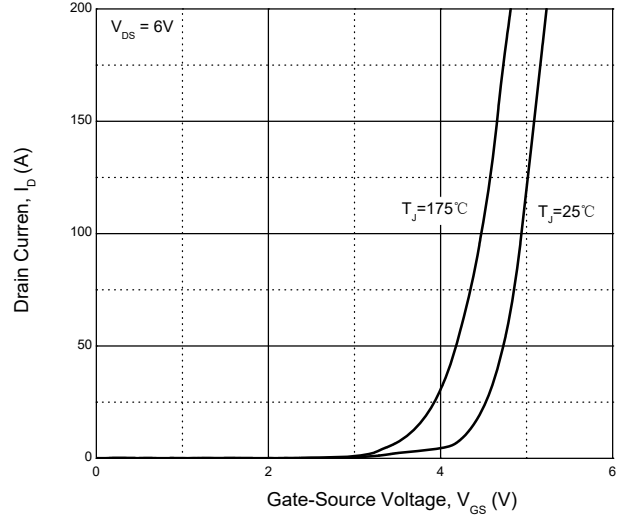


Fig. 3 - Drain-Source On-Resistance

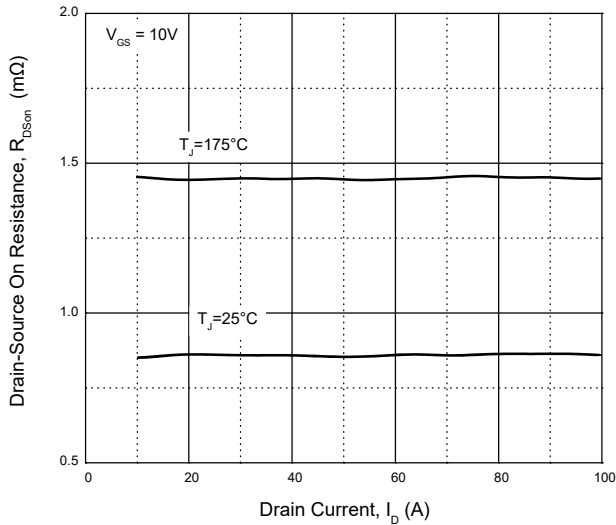


Fig. 4 - Normalized On-Resistance

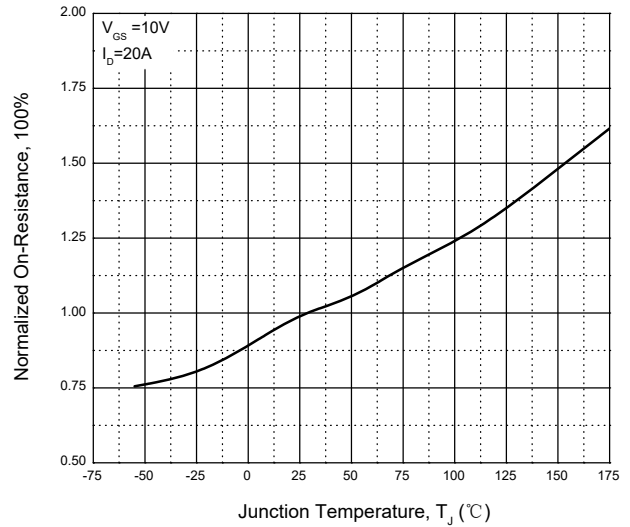


Fig. 5 - Drain-Source On-Resistance

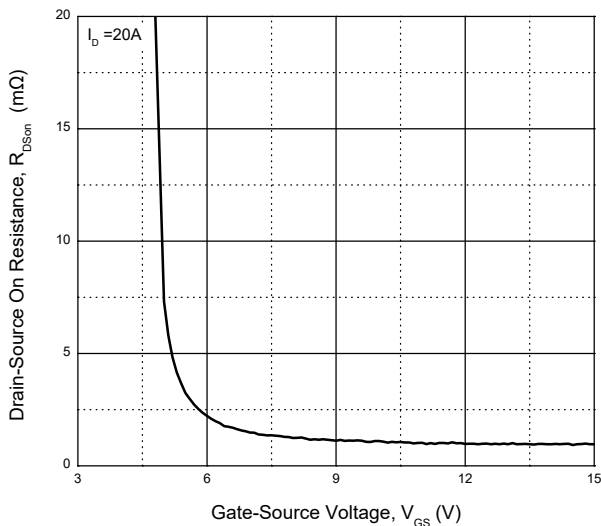
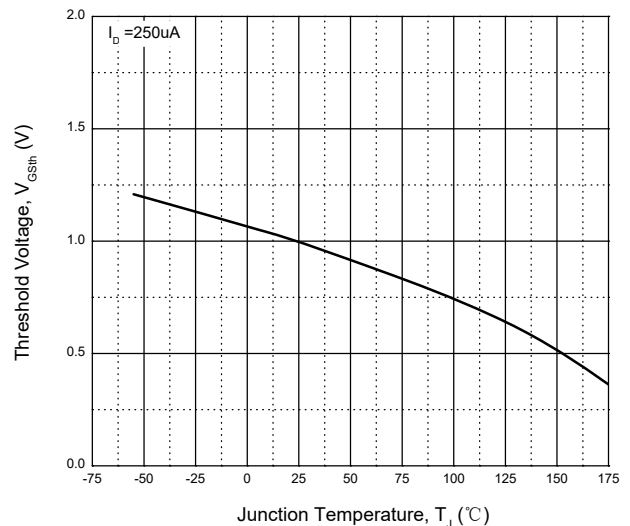


Fig. 6 - Threshold Voltage



Typical Characteristics Curves (T_J = 25°C unless otherwise noted)

Fig. 7 - Capacitance

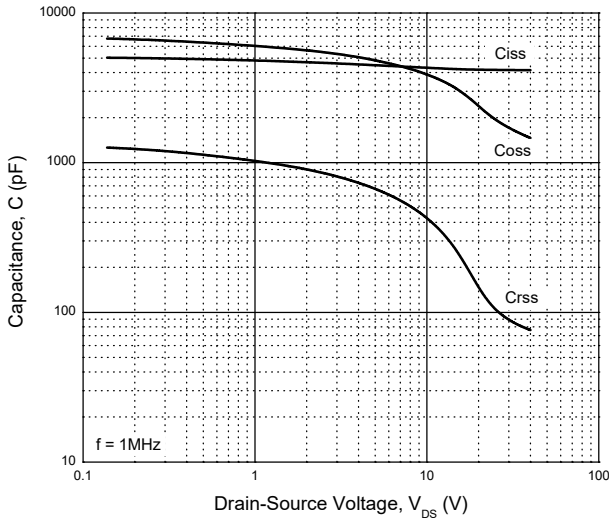


Fig. 8 - Gate Charge

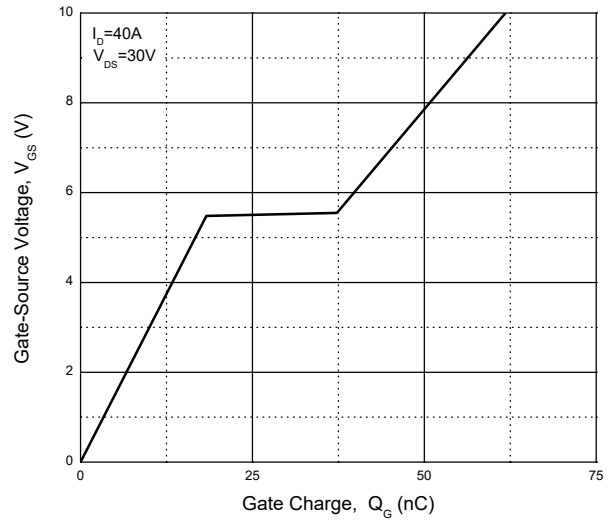


Fig. 9 - Forward Characteristic

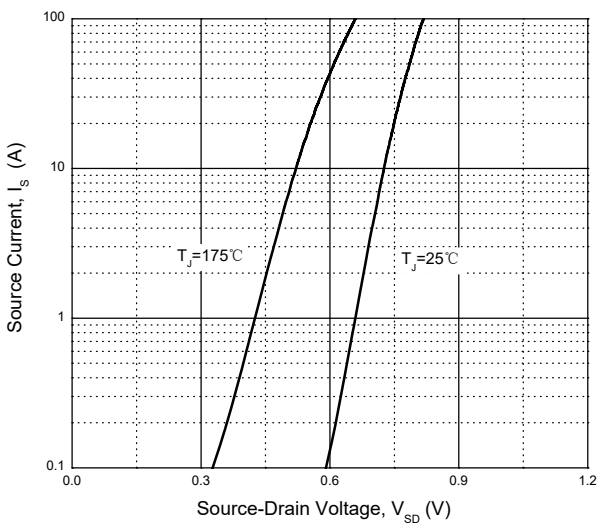


Fig. 10 - Safe Operating Area

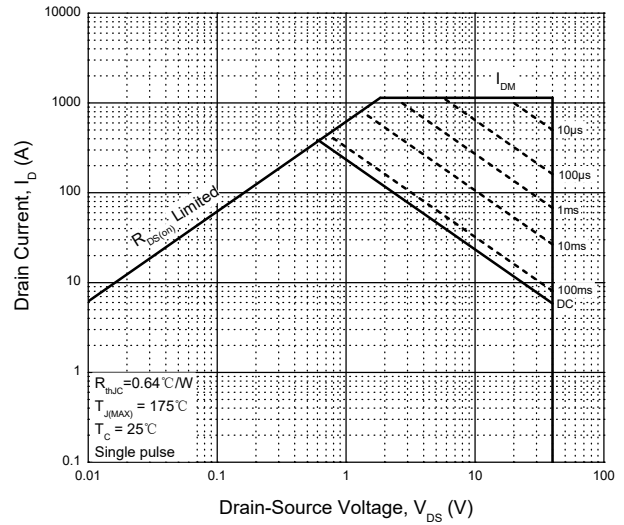
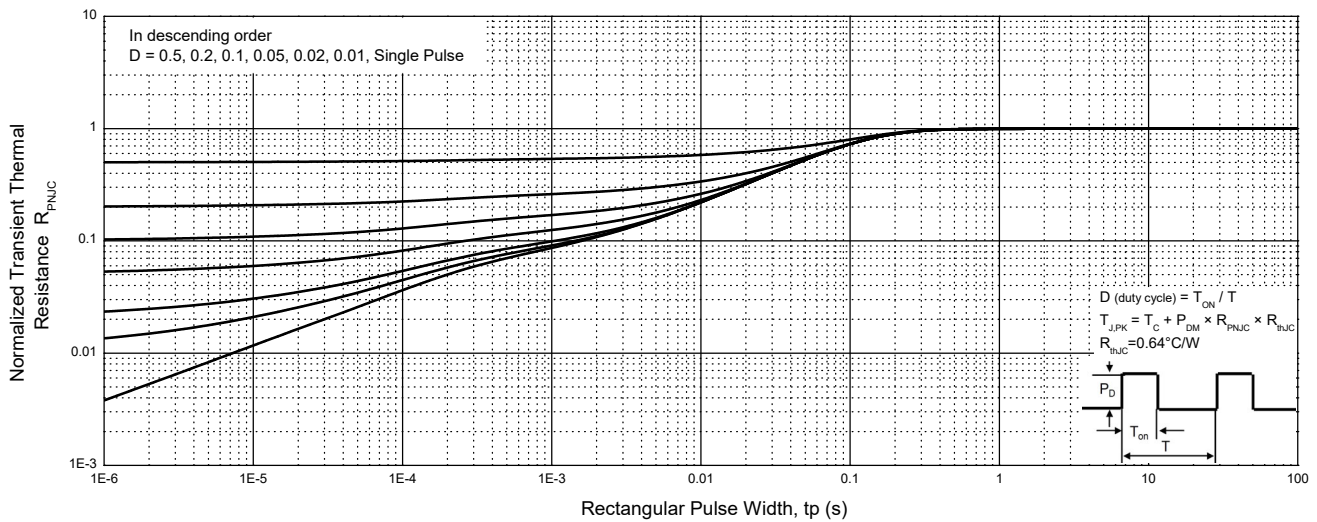


Fig.11 - Normalized Thermal Impedance, Junction-Case



Typical Characteristics Curves ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Fig. 12 - Power Derating

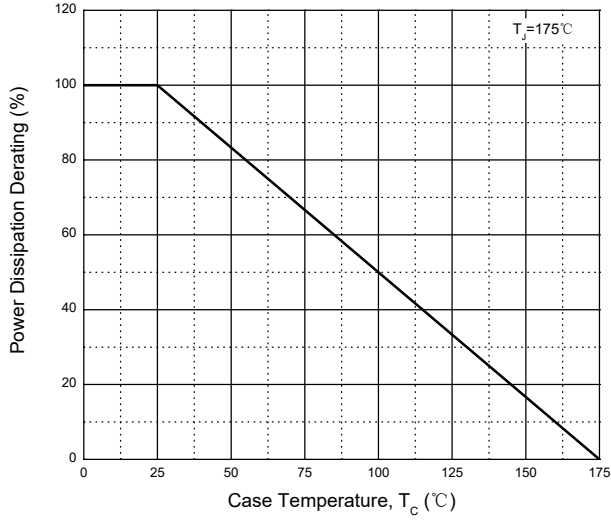
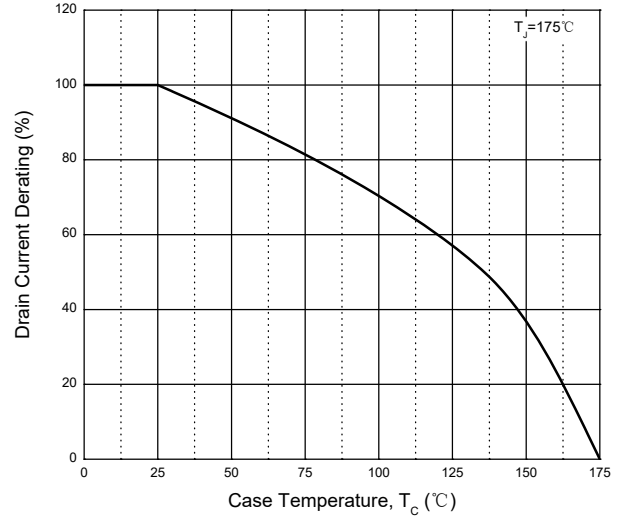
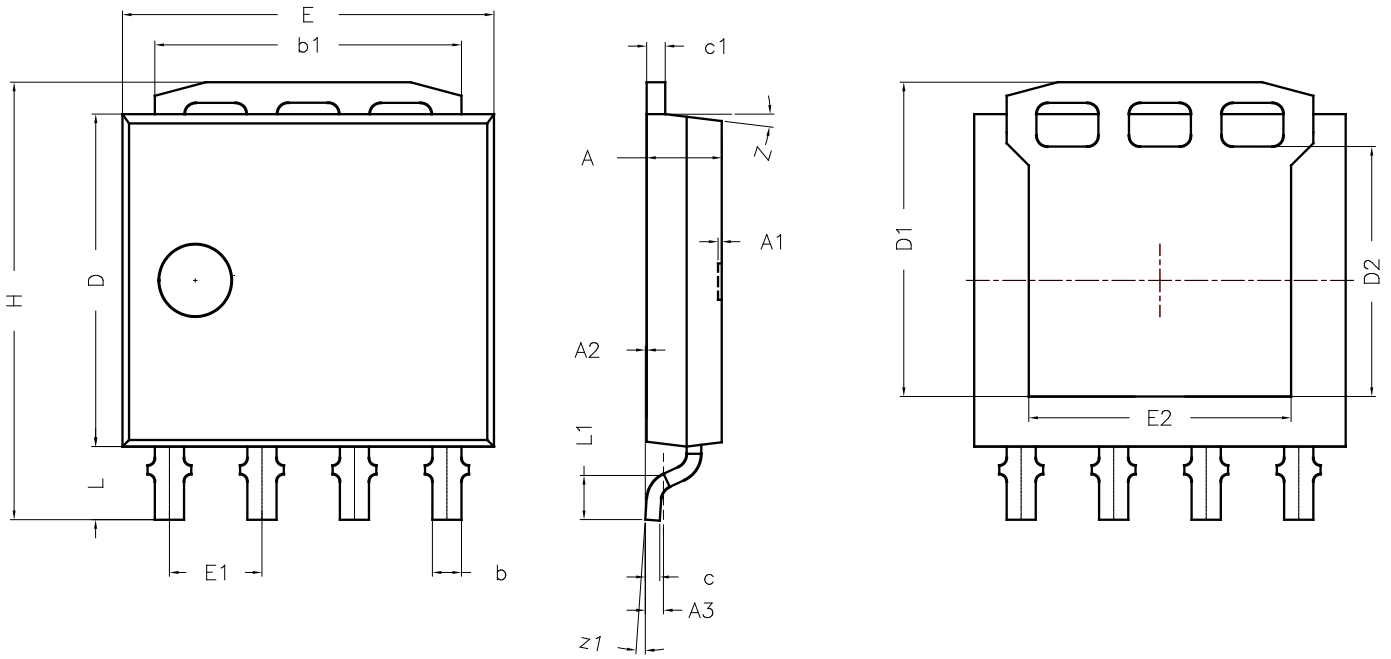


Fig. 13 - Drain Current Derating



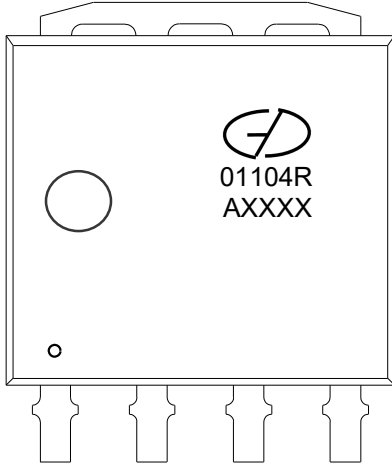
Package Outline Dimensions (Unit: millimeters)

LFPAK5060



| LFPAK5060 | | | | | | | |
|-----------|-------|-------|-------|----|-------|-------|-------|
| | Min. | Nom. | Max. | | Min. | Nom. | Max. |
| A | 0.980 | 1.030 | 1.080 | A2 | 0 | - | 0.1 |
| A1 | - | 0.050 | - | A3 | - | 0.254 | - |
| b | 0.300 | 0.400 | 0.500 | E | 5.000 | 5.100 | 5.200 |
| b1 | 4.110 | 4.210 | 4.310 | E1 | 1.170 | 1.270 | 1.370 |
| c | 0.190 | 0.200 | 0.250 | E2 | 3.450 | 3.600 | 3.750 |
| c1 | 0.240 | 0.254 | 0.300 | L | 0.800 | 1.010 | 1.300 |
| D | 4.490 | 4.590 | 4.690 | L1 | 0.300 | 0.510 | 0.750 |
| D1 | - | 4.338 | 4.800 | Z | - | 7° | - |
| D2 | - | 3.450 | - | H | 5.940 | 6.040 | 6.240 |
| Z1 | 0° | - | 8° | | | | |

Marking Outline



Part Name: AGMN01104R

1. Logo Mark: 
2. P/N Mark: 01104R
3. Date Code: AXXXX
4. Pin 1#: ○

Revision History

| Version | Date | Major Changes |
|---------|------------|------------------|
| Rev.A | 2024.04.26 | Official Release |
| | | |
| | | |

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